Automotive MOSFET

OptiMOS™ 7 Power-Transistor

RoHS

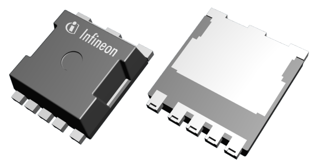
Infineon Automotive Quality

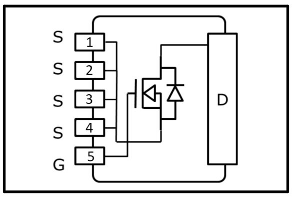
AEC Qualified

Features

- OptiMOS™ power MOSFET for automotive applications
- N-channel - Enhancement mode - Normal Level
- Extended qualification beyond AEC-Q101
- Enhanced electrical testing
- Robust design
- MSL2a up to 260°C peak reflow
- 175°C operating temperature
- RoHS compliant
- 100% Avalanche tested

PG-HSOF-5-2





Potential Applications

General automotive applications.

Product Validation

Qualified for automotive applications. Product validation according to AEC-Q101.

Product Summary

V_{DS}	40	V
$R_{DS(on)}$	0.82	mΩ
I_D (chip limited)	290	A

Type	**Package**	**Marking**
IAUAN04S7N008	PG-HSOF-5-2	7N04N008

Table of Contents

Maximum Ratings

at T_j = 25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Continuous drain current	I_D	V_{GS} = 10 V, Chip limitation[1,2]	290	A
		V_{GS} = 10 V, DC current	180	
		T_a = 100°C, V_{GS} = 10 V, R_{thJA} on 2s2p[2,3]	40	
Pulsed drain current[2]	$I_{D,pulse}$	T_C = 25°C, t_p = 100 µs	915	
Avalanche energy, single pulse[2]	E_{AS}	I_D = 70 A	153	mJ
Avalanche current, single pulse	I_{AS}	–	140	A
Gate source voltage	V_{GS}	–	±20	V
Power dissipation	P_{tot}	T_C = 25°C	133	W
Operating and storage temperature	T_j, T_{stg}	–	-55 ... +175	°C

Thermal Characteristics[2)]

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction - case	R_{thJC}	–	–	–	1.12	K/W
Thermal resistance, junction - ambient[3)]	R_{thJA}	–	–	23.6	–	

Electrical Characteristics

at T_j=25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Static Characteristics						
Drain-source breakdown voltage	$V_{(Br)DSS}$	V_{GS} = 0 V, I_D = 1 mA	40	–	–	V
Gate threshold voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = 60 µA	2.2	2.6	3.0	
Zero gate voltage drain current	I_{DSS}	V_{DS} = 40 V, V_{GS} = 0 V, T_j = 25°C	–	–	1	µA
		V_{DS} = 40 V, V_{GS} = 0 V, T_j = 100°C[2)]	–	–	15	
Gate-source leakage current	I_{GSS}	V_{GS} = 20 V, V_{DS} = 0 V	–	–	100	nA
Drain-source on-state resistance	$R_{DS(on)}$	V_{GS} = 7 V, I_D = 45 A	–	0.89	1.05	mΩ
		V_{GS} = 10 V, I_D = 90 A	–	0.70	0.82	
Gate resistance[2)]	R_G	–	–	1.3	–	Ω

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Dynamic Characteristics[2]						
Input capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = 20 V, f = 1 MHz	–	4160	5410	pF
Output capacitance	C_{oss}		–	2420	3150	
Reverse transfer capacitance	C_{rss}		–	80	120	
Turn-on delay time	$t_{d(on)}$	V_{DD} = 20 V, V_{GS} = 10 V, I_D = 90 A, R_G = 3.5 Ω	–	9	–	ns
Rise time	t_r		–	6	–	
Turn-off delay time	$t_{d(off)}$		–	21	–	
Fall time	t_f		–	12	–	

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Gate Charge Characteristics[2]						
Gate to source charge	Q_{gs}	V_{DD} = 20 V, I_D = 90 A, V_{GS} = 0 to 10 V	–	17	22	nC
Gate to drain charge	Q_{gd}		–	12	18	
Gate charge total	Q_g		–	60	78	
Gate plateau voltage	$V_{plateau}$		–	4.2	–	V

Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Reverse Diode						
Diode continuous forward current[2]	I_S	T_C = 25°C	–	–	180	A
Diode pulse current[2]	$I_{S,pulse}$	T_C = 25°C, t_p = 100 µs	–	–	915	
Diode forward voltage	V_{SD}	V_{GS} = 0 V, I_F = 90 A, T_j = 25°C	–	0.8	0.95	V
Reverse recovery time[2]	t_{rr}	V_R = 20 V, I_F = 50 A, di_F/dt = 100 A/µs	–	41	62	ns
Reverse recovery charge[2]	Q_{rr}		–	33	66	nC

[1] Practically the current is limited by the overall system design including the customer-specific PCB.

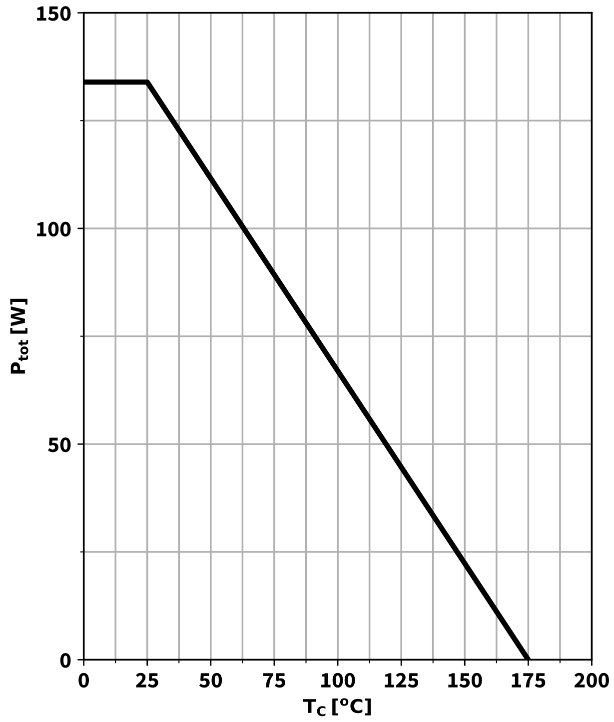
[2] The parameter is not subject to production testing – specified by design.

[3] Device on 2s2p FR4 PCB defined in accordance with JEDEC standards (JESD51-5, -7). PCB is vertical in still air.

Electrical characteristics diagrams

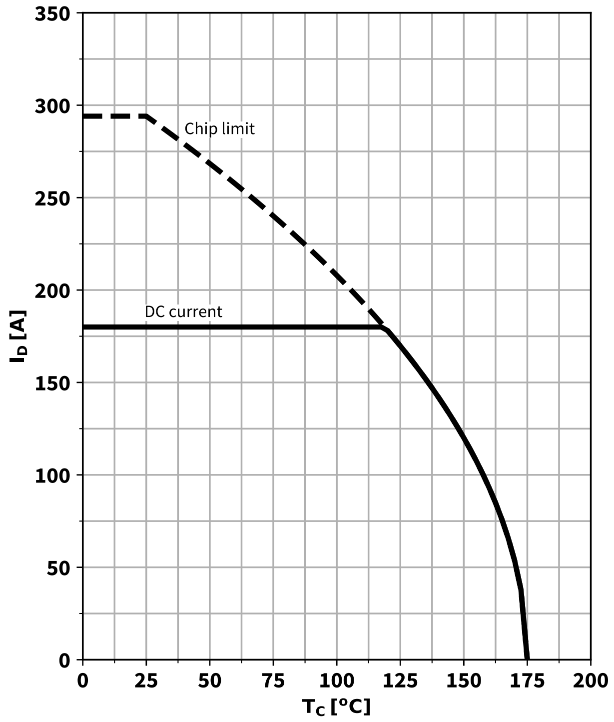
1 Power dissipation

$P_{tot} = f(T_C); V_{GS} \geq 6$ V



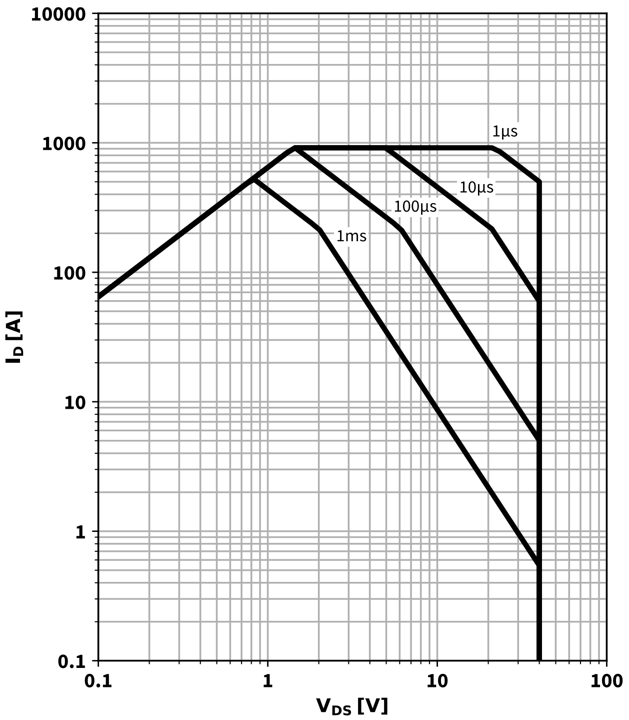
2 Drain current

$I_D = f(T_C); V_{GS} \geq 6$ V



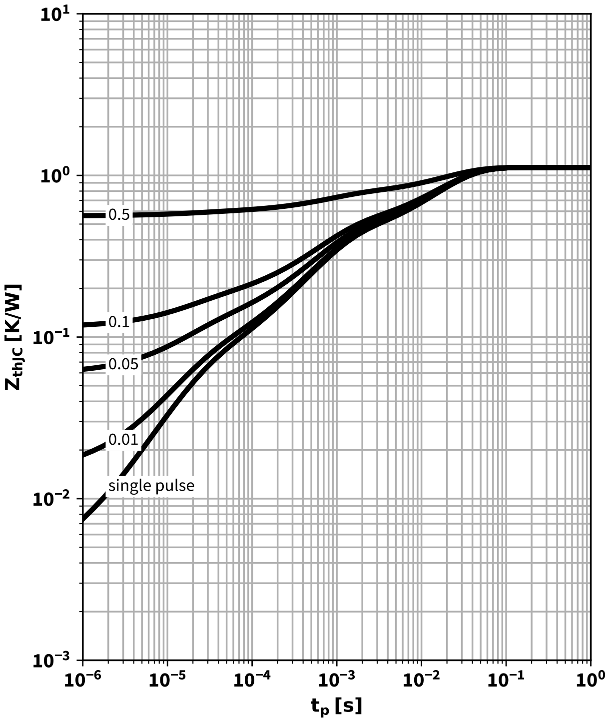
3 Safe operating area

$I_D = f(V_{DS}); T_C = 25$ °C; $D = 0$; parameter: t_p



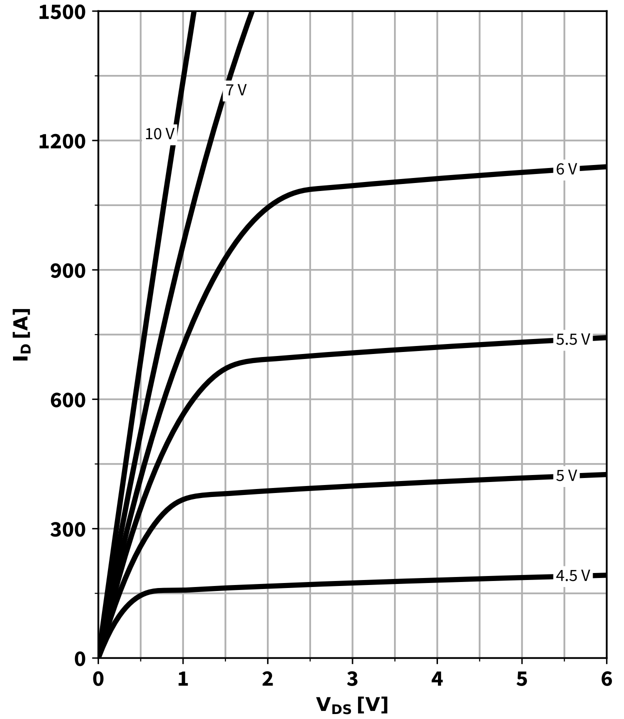
4 Max. transient thermal impedance

$Z_{thJC} = f(t_p)$; parameter: $D = t_p/T$



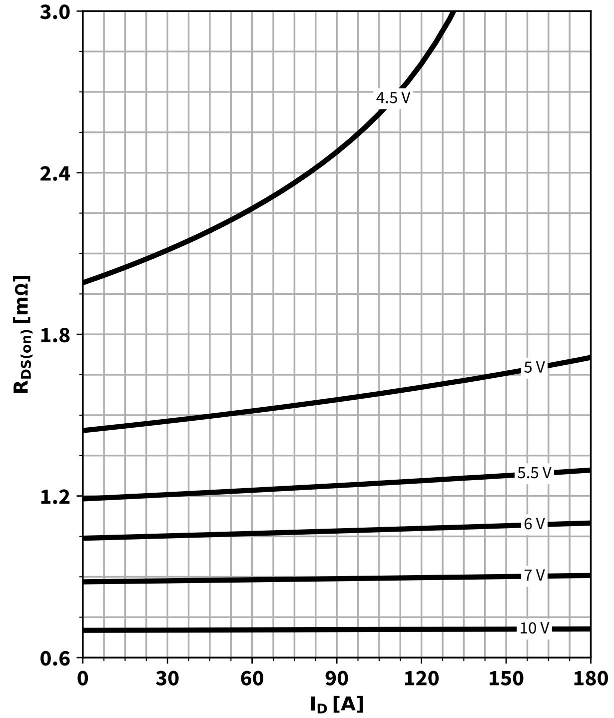
5 Typ. output characteristics

$I_D = f(V_{DS})$; $T_j = 25°C$; parameter: V_{GS}



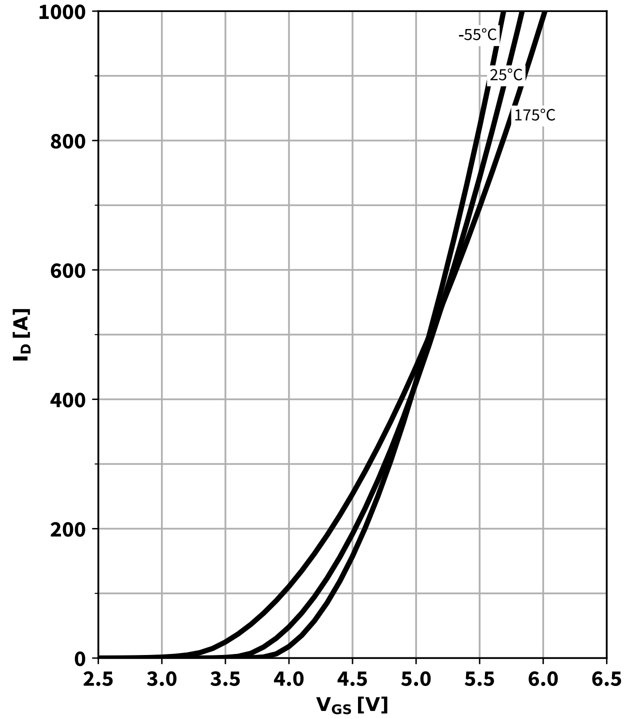
6 Typ. drain-source on-state resistance

$R_{DS(on)} = f(I_D)$; $T_j = 25$ °C; parameter: V_{GS}



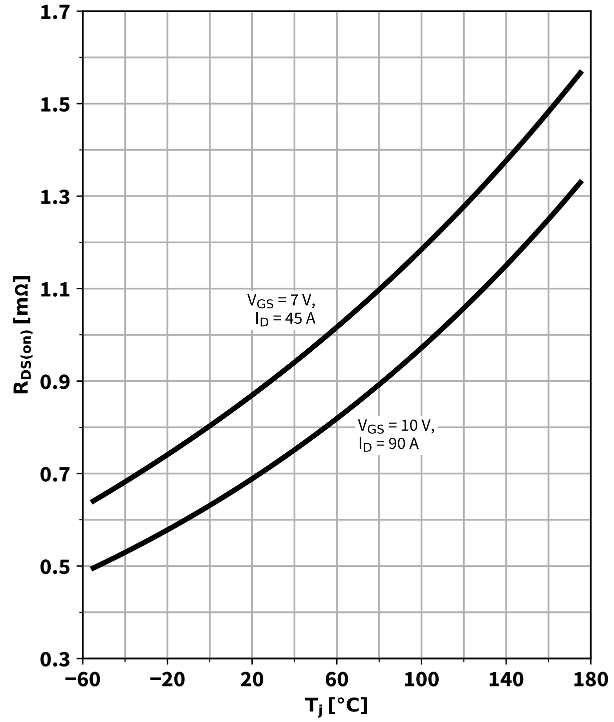
7 Typ. transfer characteristics

$I_D = f(V_{GS})$; $V_{DS} = 6$ V; parameter: T_j



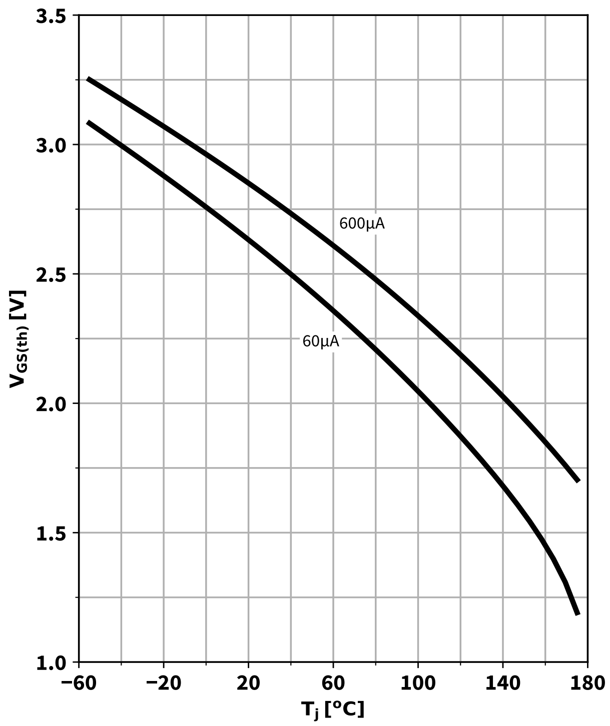
8 Typ. drain-source on-state resistance

$R_{DS(on)} = f(T_j)$; parameter: I_D, V_{GS}



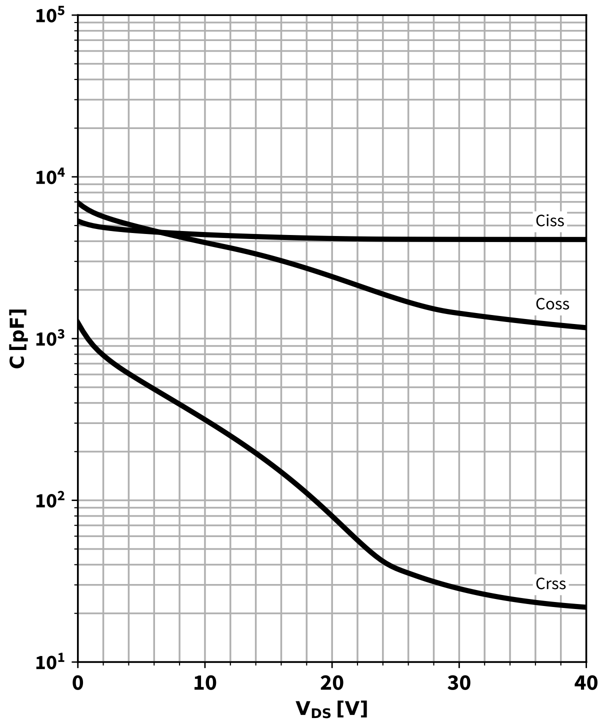
9 Typ. gate threshold voltage

$V_{GS(th)} = f(T_j)$; $V_{GS} = V_{DS}$; parameter: I_D



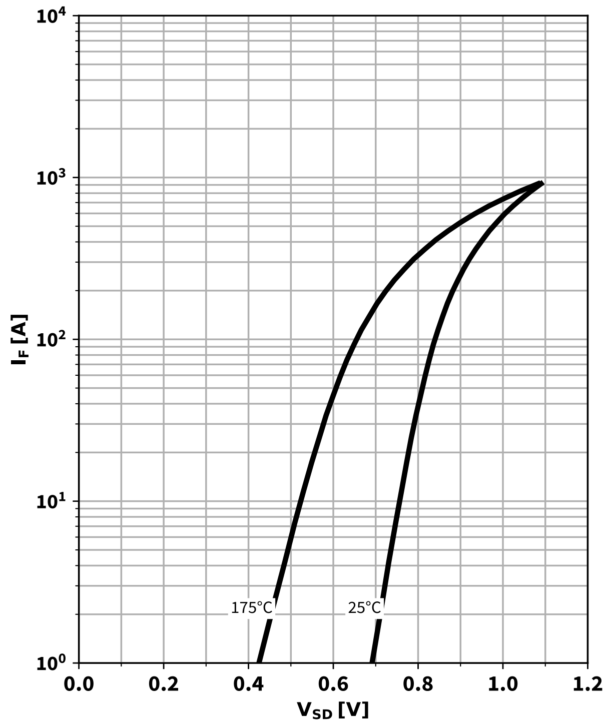
10 Typ. capacitances

$C = f(V_{DS})$; $V_{GS} = 0$ V; $f = 1$ MHz



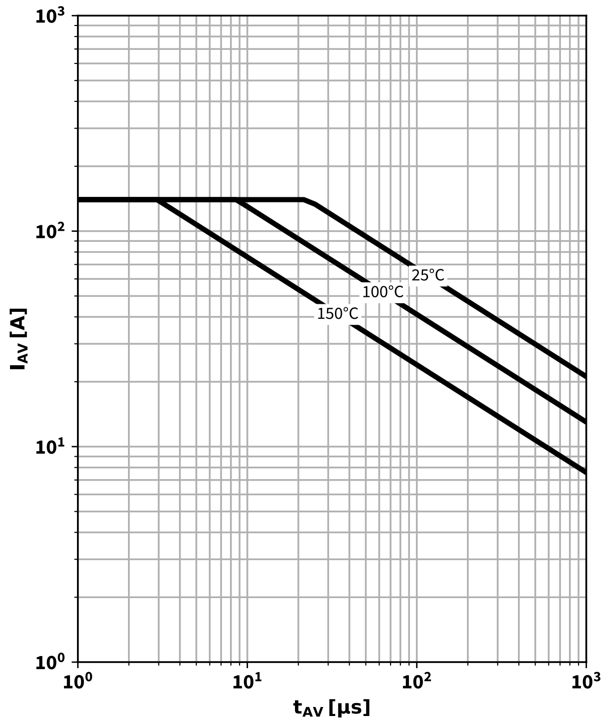
11 Typ. forward diode characteristics

$I_F = f(V_{SD})$; parameter: T_j



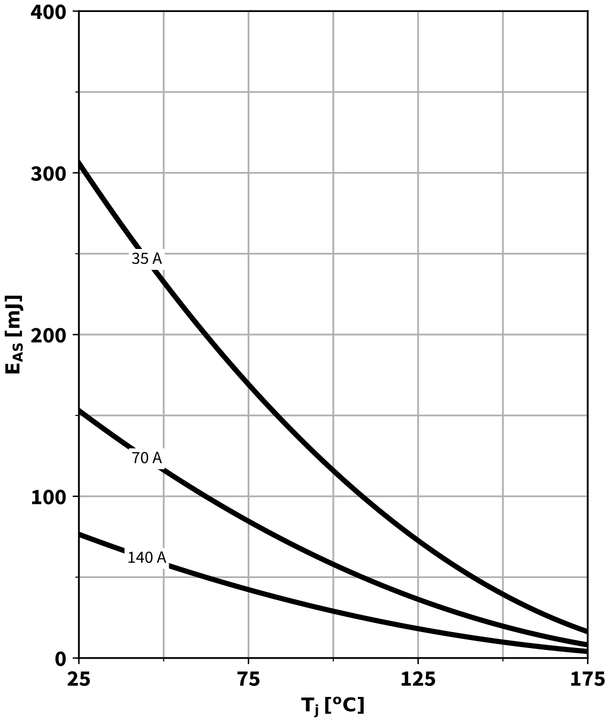
12 Typ. avalanche characteristics

$I_{AS} = f(t_{AV})$; parameter: $T_{j(start)}$



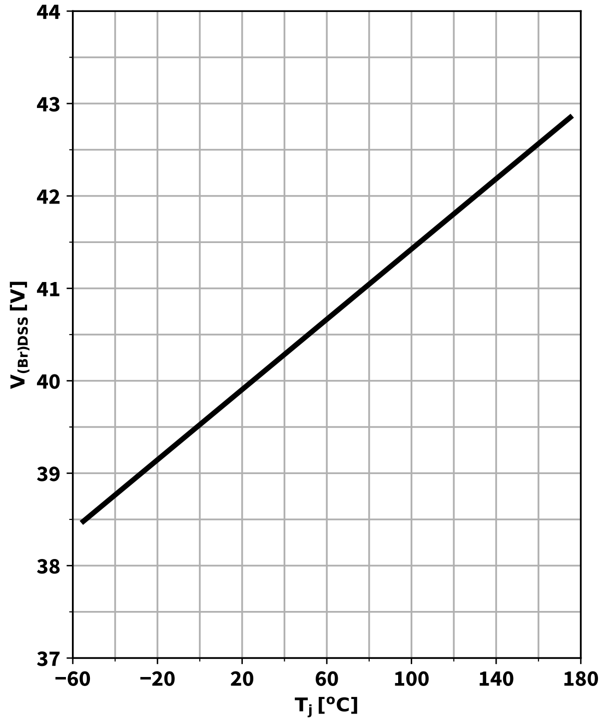
13 Typical avalanche energy

$E_{AS} = f(T_j)$; parameter: I_D



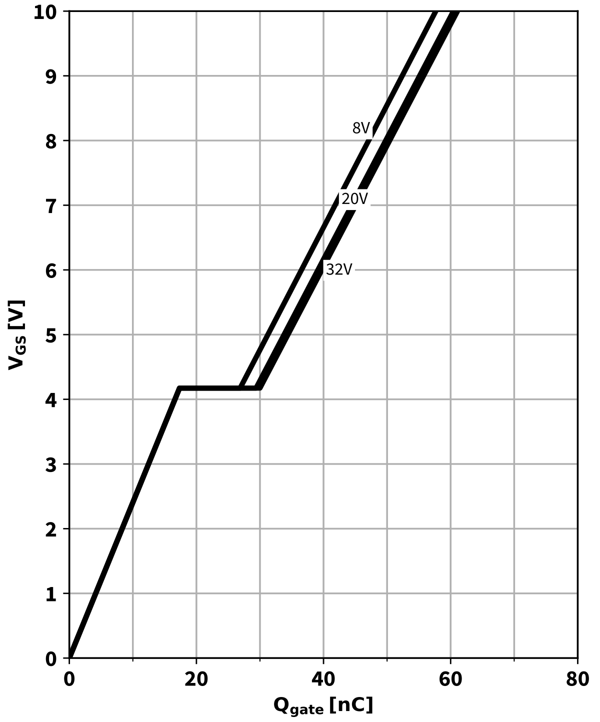
14 Drain-source breakdown voltage

$V_{(Br)DSS} = f(T_j)$; $I_D = 1$ mA

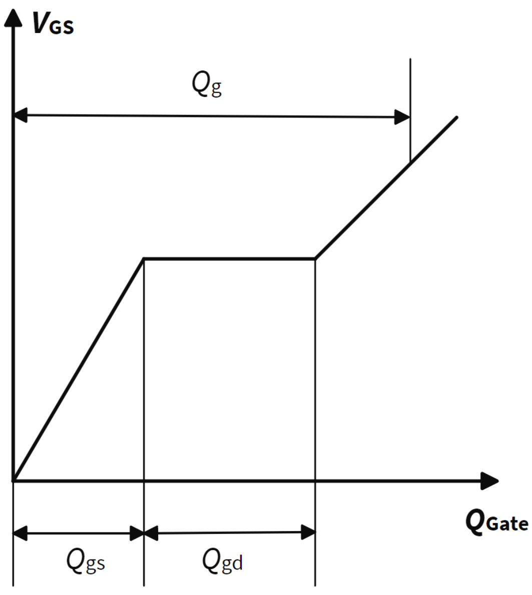


15 Typ. gate charge

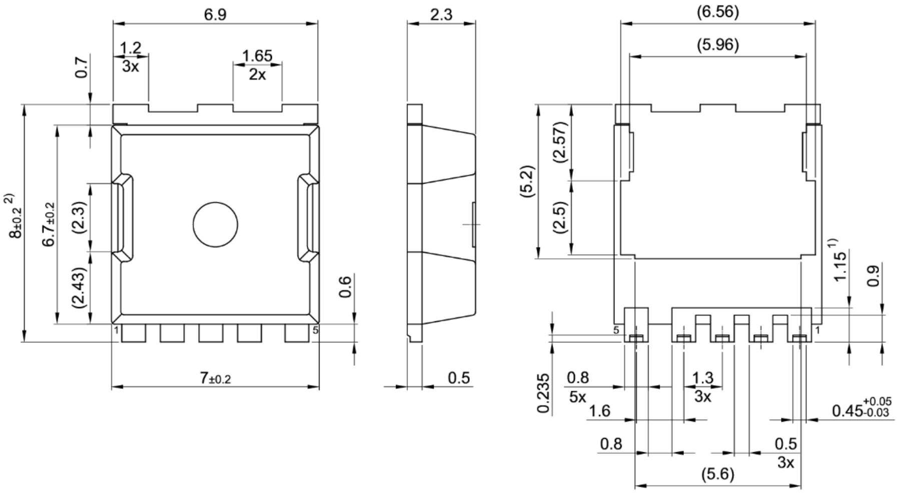
$V_{GS} = f(Q_{gate})$; $I_D = 90$ A pulsed; parameter: V_{DD}



16 Gate charge waveforms

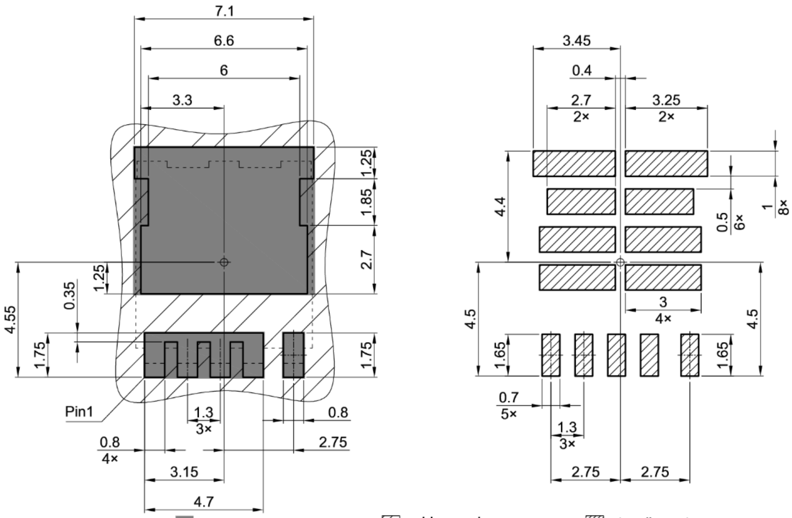


Package Outline



1) Lead length up to anti flash profile; mold flashes excluded
2) Excluding burr
All dimensions are in units mm
The drawing is in compliance with ISO 128-30, Projection Method 1 [⊲◎]

Footprint



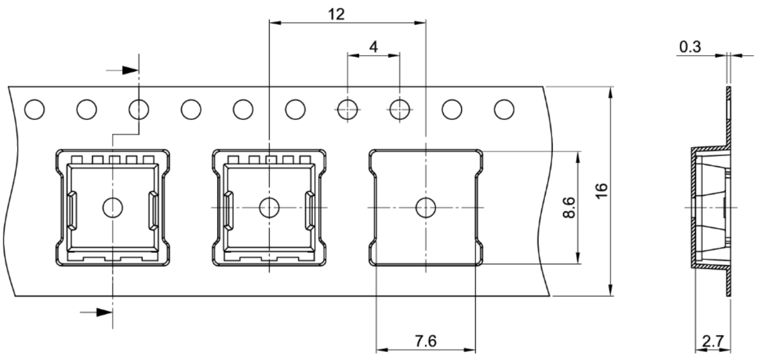
copper

solder mask

stencil apertures

Based on stencil thickness 0.13 mm
All pads are solder mask defined
All dimensions are in units mm

Packaging



All dimensions are in units mm
The drawing is in compliance with ISO 128-30, Projection Method 1 [⊲◎]

Revision History

Revision	Date	Changes
Revision 1.0	2024-04-09	Final Data Sheet

Trademarks
All referenced product or service names and trademarks are the property of their respective owners.

Edition 2024-04-09

Published by

Infineon Technologies AG

81726 Munich, Germany

Do you have any questions about any aspect of this document?

Email: erratum@infineon.com

Document reference
IAUAN04S7N008-Data-Sheet-10-Infineon